



SIGPRO

SIGPRO Wireless Inc.

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**Press
Release**

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SIGPRO Wireless Presents Critical 3G Technology to Leading European PCD OEMs

Ottawa-based start-up to be star of Canada's 3G Trade Mission to Europe

Ottawa, Canada – May 15, 2002 – SIGPRO Wireless Inc., a pioneer in chip design for next generation PCDs (Personal Communication Devices), based in Ottawa, will present its breakthrough flagship product, the Flexium™ chip to leading European mobile phone manufacturers at the Canada Sweden Business Association's (CSBA) 'Understanding the Wireless Universe' event in Stockholm Sweden as part of Canada's 3G Trade Mission to Sweden. Several other meetings with leading PCD OEMs that have expressed interest in SIGPRO's breakthrough technology are planned in Europe following the CSBA event.

SIGPRO was selected from the many companies vying to be the showpiece of CSBA event held as part of the Canadian 3G Trade Mission in Europe. The purpose of this mission is to promote the Canadian Wireless industry to potential business partners in Europe. The other countries on the Mission's itinerary are Finland and Germany.

The Canada Sweden Business Association event, which will take place on May 16, 2002, aims to bring together European and Canadian wireless companies to discuss complementary business arrangements. Companies invited rank among the elite of technology innovators, mobile phone manufacturers and service providers. SIGPRO's Founder and CEO, Dr. Sundara Murthy, will join an exclusive panel of wireless industry visionaries to introduce SIGPRO's breakthrough architecture for next generation mobile phones. Dr. Murthy will join Chris Bannister, the CEO of Hi3G Access, and Bernt Ericsson, the vice president of Ericsson Foresight, in introducing new services and new applications that 3G mobile infrastructure will enable.

SIGPRO Wireless CEO Dr. Sundara Murthy elaborates, "This is a terrific opportunity for SIGPRO Wireless to launch our Flexium™ chip in Europe as we will be presenting to a hand-picked audience of wireless (manufacturing and service) industry and strategic financing leaders from all over the continent, along with the CEO of Hi3G, the holders of the Swedish and Danish 3G licenses, and the Vice President of Ericsson Foresight, the long term futures center for Ericsson". Other keynote speakers at the seventh annual CSBA event will include Margaret

Bloodworth, Deputy Minister of Transport for Canada, and Charles Meyer, Vice-President of Research in Motion.

Following the Canada Sweden Business Association 'Understanding the Wireless Universe' event, SIGPRO Wireless will join Canada's 3G Trade Mission in Stockholm, Sweden. As part of the 3G Trade Mission SIGPRO Wireless will meet with leading 3G mobile handset manufacturers and 3G service providers to introduce the Flexium™ Chip. The Flexium™ is the wireless mobility industry's first System on Chip SoC solution that will enable true global roaming, as well as the convergence of multiple applications such as voice and text messaging, internet browsing, email, PDA, GPS (Global Positioning System), MPEG-4 streaming video, MP-3 entertainment and various computational applications for next generation 3G and 4G mobile phones. "The timing for both events is perfect, SIGPRO has had a great deal of product interest in Europe and we are pleased to take a lead role in such high profile events" explained Dr. Murthy. On the agenda for the 3G trade mission for SIGPRO Wireless are meetings with Ericsson Telecom, Hi3G, Telia, and receptions organized by Brain Heart Capital - Europe's largest Wireless only venture capital organization, and Evli Securities - a major Nordic Investment bank focused on the mobile and wireless sector.

As part of this business trip, meetings have also been scheduled between SIGPRO executives and key supply chain and R&D executives from several leading European PCD OEMs that have expressed keen interest for SIGPRO's breakthrough technology.

"This summer will be very exciting for SIGPRO Wireless as we move from research and development to the commercialization of the Flexium™ chip. We look forward to engaging customers for trial during the second half of 2002" commented Dr. Murthy.

About SIGPRO Wireless Inc.

Founded in May 2000 by Dr. Sundara Murthy, a leading expert in digital communications technology, SIGPRO Wireless is engaged in the development of critical System-on-Chip (SoC) and associated software solutions for next-generation wireless mobility Personal Communication Devices (PCDs). With a pioneering architecture, SIGPRO's programmable Flexium™ chip supports a variety of worldwide standards, data rates, protocols, services and applications. With Flexium™ inside, the next generation wireless PCD will 'empower the individual' with a multitude of personal communication (cell phone), computation (palm computers), information (email, web), navigation (GPS), and entertainment (MPEG4, MP3) services. Flexium™ is the leading technology 'convergence enabler' to deliver 'All-in-one' integrated services to people on the move. Headquartered in Ottawa, Ontario, Canada, SIGPRO is in the process of opening offices in Southern California and Southern India.

For more information about SIGPRO, please email us: marketing@sigprowireless.com or visit our web site at <http://www.sigprowireless.com> or call us at 613 727 1161.